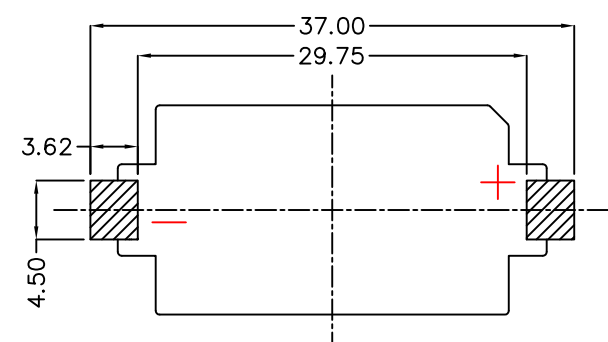
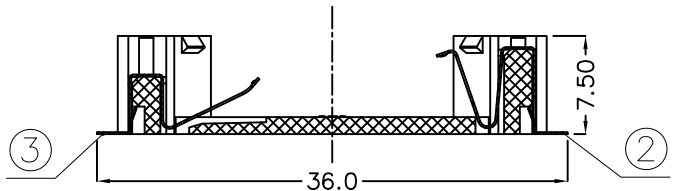
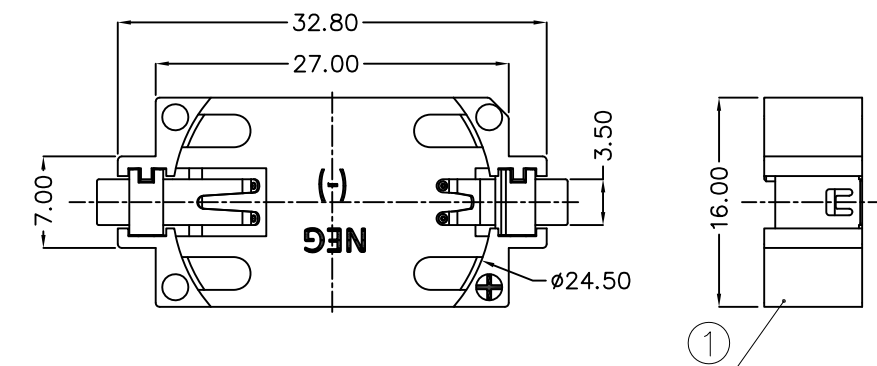




REV.	ECN NO.	REVISED	DATE

NOTE:

- 1.MATERIAL:  
 a.HOUSING: LCP UL94V-0  
 b.CONTACT:PHOSPHOR BRONZE  
 (SURFACE PLATING: Au1u")  
 SEE ORDERING INFORMATION
- 2.ELECTRIC:  
 a.CONTACT RESISTANCE: 30 MILLIOHMS MAX  
 b.INSULATION RESISTANCE: 1000 MEGA OHMS MIN  
 c.DIELECTNIC VOLTAGE: 500V AC ONE SEC LEVEL  
 d.OPERATING TEMPERATURE: -25° C ~ +85° C



PCB Layout Diagram  
Top View

ORDERING INFORMATION

BS-24-B\*\*\*016

电池座系列  
 BS-24系列  
 SMT 180° TYPE

PLATING:  
 A-Au1U"  
 J-Ni100U"~120U"  
 K-Sn100U"~120U"

MATERIAL:  
 1A-PBT BLACK  
 1B-PA66 BLACK  
 2A-PPA BROWN  
 2B-PPA BLACK  
 3A-PPS BROWN  
 3B-PPS BLACK  
 4A-LCP WHITE  
 4B-LCP BLACK



3	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.15mm	Gold Plating and Ni Under-Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.15mm	Gold Plating and Ni Under-Plating
1	HOUSE	1	LCP UL94 V-0	WHITE
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES		<b>MYOUNG 美阳</b> <a href="http://www.meiyangdz.com">www.meiyangdz.com</a>	
DECIMALS: X :±0.30 X.X :±0.25 X.XX :±0.20 X.XXX :±0.10	ANGLES: X :±1° X.X :±0.5°	DSND YangFeng	DATE 2018-05-30
WEIGHT:		CHKD ZhouRuicai	DATE 2018-05-30
SHEET 1 OF 1		APVD XueShunyong	DATE 2018-05-30
TITLE:		SCALE:	SIZE: A4
VIEW:		UNIT: mm	REV.: A/0
PART NO.:		OBJECT: MY	DRAW NO.:MY-CP-0138
BS-24-B4AA016			